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## X3-Class HiPerFET ${ }^{\text {M }}$ Power MOSFET

## N-Channel Enhancement Mode Avalanche Rated



| Symbol | Test Conditions | Maximum Ratings |  |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {DSs }}$ | $\mathrm{T}_{J}=25^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ | 250 | V |
| $\mathrm{V}_{\text {DGR }}$ | $\mathrm{T}_{J}=25^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{GS}}=1 \mathrm{M} \Omega$ | 250 | V |
| $\mathrm{V}_{\text {Gss }}$ | Continuous | $\pm 20$ | V |
| $\mathrm{V}_{\text {GSM }}$ | Transient | $\pm 30$ | V |
| $\mathrm{I}_{\mathrm{D} 25}$ | $\mathrm{T}_{\mathrm{c}}=25^{\circ} \mathrm{C}$ | 120 | A |
| $\mathrm{I}_{\mathrm{DM}}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$, Pulse Width Limited by $\mathrm{T}_{\text {JM }}$ | 230 | A |
| $\mathrm{I}_{\text {A }}$ | $\mathrm{T}_{\mathrm{c}}=25^{\circ} \mathrm{C}$ | 60 | A |
| $\mathrm{E}_{\text {AS }}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 1.2 | $J$ |
| dv/dt | $\mathrm{I}_{\mathrm{S}} \leq \mathrm{I}_{\mathrm{DM}}, \mathrm{V}_{\mathrm{DD}} \leq \mathrm{V}_{\text {DSS }}, \mathrm{T}_{\mathrm{J}} \leq 150^{\circ} \mathrm{C}$ | 20 | V/ns |
| $\mathrm{P}_{\mathrm{D}}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 480 | W |
| $\mathrm{T}_{J}$ |  | $-55 \ldots+150$ | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {JM }}$ |  | 150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ |  | $-55 \ldots+150$ | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{L}}$ | Maximum Lead Temperature for Soldering | 300 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {sold }}$ | 1.6 mm (0.062in.) from Case for 10s | 260 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{M}_{\mathrm{d}}$ | Mounting Torque (TO-247 \& TO-3P) | 1.13 / 10 | Nm/lb.in |
| Weight | TO-268HV | 4.0 | g |
|  | TO-3P | 5.5 | g |
|  | TO-247 | 6.0 | g |


| Symbol Test Conditions$\left(T_{J}=25^{\circ} \mathrm{C}\right.$, Unless Otherwise Specified) |  | Characteristic Values |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |
| $\mathrm{BV}_{\text {DSs }}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=1 \mathrm{~mA}$ | 250 |  | V |
| $\mathrm{V}_{\text {GS(th) }}$ | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{I}_{\mathrm{D}}=4 \mathrm{~mA}$ | 2.5 |  | 4.5 V |
| $\mathrm{I}_{\text {GSS }}$ | $\mathrm{V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}$ |  |  | $\pm 100 \mathrm{nA}$ |
| $\mathrm{I}_{\text {DSS }}$ | $V_{\text {DS }}=\mathrm{V}_{\text {DSS }}, \mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}$ |  |  | $\begin{array}{r} 10 \mu \mathrm{~A} \\ 500 \mu \mathrm{~A} \end{array}$ |
| $\mathrm{R}_{\text {DS(on) }}$ | $V_{G S}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=0.5 \cdot \mathrm{I}_{\mathrm{D} 25}$, Note 1 |  | 10 | $12 \mathrm{~m} \Omega$ |

$V_{\text {DSs }}=250 \mathrm{~V}$
$I_{D 25}=120 \mathrm{~A}$
$\mathrm{R}_{\mathrm{DS}(\text { on })}$

TO-268HV (IXFT)


TO-3P (IXFQ)



G = Gate D = Drain
$S=$ Source $\quad$ Tab $=$ Drain

## Features

- International Standard Packages
- Low $R_{\text {DS(ON) }}$ and $Q_{G}$
- Avalanche Rated
- Low Package Inductance


## Advantages

- High Power Density
- Easy to Mount
- Space Savings


## Applications

- Switch-Mode and Resonant-Mode

Power Supplies

- DC-DC Converters
- PFC Circuits
- AC and DC Motor Drives
- Robotics and Servo Controls

| $\begin{aligned} & \text { Symbol } \quad \text { Test Conditions } \\ & \left(T_{j}=25^{\circ} \mathrm{C}\right. \text {, Unless Otherwise Specified) } \end{aligned}$ |  | Characteristic Values |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max |
| $\mathrm{g}_{\text {fs }}$ | $\mathrm{V}_{\mathrm{DS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=60 \mathrm{~A}$, Note 1 | 54 | 90 | S |
| $\underline{\mathrm{R}_{\text {Gi }}}$ | Gate Input Resistance |  | 1.6 | $\Omega$ |
| $\begin{aligned} & \mathrm{C}_{\text {iss }} \\ & \mathrm{C}_{\text {oss }} \\ & \mathrm{C}_{\mathrm{rss}} \end{aligned}$ | \} $V_{G S}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=25 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |  | $\begin{array}{r} 7870 \\ 1260 \\ 2 \end{array}$ | pF pF pF |
| $\begin{aligned} & \mathrm{C}_{\mathrm{o}(\mathrm{er})} \\ & \mathrm{C}_{\mathrm{o}(\mathrm{r})} \end{aligned}$ | Effective Output Capacitance $\left.\begin{array}{l} \text { Energy related } \\ \text { Time related } \end{array}\right\} \begin{aligned} & \mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{DS}}=0.8 \cdot \mathrm{~V}_{\mathrm{DSS}} \end{aligned}$ |  | $\begin{array}{r} 500 \\ 1900 \end{array}$ | pF pF |
| $\begin{aligned} & t_{d(o n)} \\ & t_{r} \\ & t_{d(\text { off })} \\ & t_{f} \\ & \hline \end{aligned}$ | Resistive Switching Times $\left\{\begin{array}{l} \mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0.5 \cdot \mathrm{~V}_{\mathrm{DSS}}, \mathrm{I}_{\mathrm{D}}=0.5 \cdot \mathrm{I}_{\mathrm{D} 25} \\ \mathrm{R}_{\mathrm{G}}=5 \Omega \text { (External) } \end{array}\right.$ |  | $\begin{array}{r} 29 \\ 32 \\ 100 \\ 12 \end{array}$ | ns ns ns ns |
| $\begin{aligned} & \mathbf{Q}_{\mathrm{g}(\text { on })} \\ & \mathbf{Q}_{\mathrm{gs}} \\ & \mathbf{Q}_{\mathrm{gd}} \end{aligned}$ | \} $\mathrm{V}_{G S}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0.5 \cdot \mathrm{~V}_{\mathrm{DSS}}, \mathrm{I}_{\mathrm{D}}=0.5 \cdot \mathrm{I}_{\mathrm{D} 25}$ |  | 122 40 34 | nC nC nC |
| $\mathrm{R}_{\mathrm{thJc}}$ <br> $\mathrm{R}_{\mathrm{thcs}}$ | TO-247\& TO-3P |  | 0.21 | $\begin{array}{r} 0.26^{\circ} \mathrm{C} / \mathrm{W} \\ { }^{\circ} \mathrm{C} / \mathrm{W} \end{array}$ |

## Source-Drain Diode

| $\begin{aligned} & \text { Symbol Test Conditions } \\ & \left(T_{j}=25^{\circ} \mathrm{C}\right. \text {, Unless Otherwise Specified) } \end{aligned}$ |  | Characteristic Values |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max |  |
| $\mathrm{I}_{\text {s }}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}$ |  |  | 120 | A |
| $\mathrm{I}_{\text {SM }}$ | Repetitive, pulse Width Limited by $\mathrm{T}_{\mathrm{JM}}$ |  |  | 480 | A |
| $\mathrm{V}_{\text {sD }}$ | $\mathrm{I}_{\mathrm{F}}=\mathrm{I}_{\mathrm{S}}, \mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}$, Note 1 |  |  | 1.4 | V |
| $\left.\begin{array}{l} \mathrm{t}_{\mathrm{rr}} \\ \mathrm{Q}_{\mathrm{RM}} \\ \mathrm{I}_{\mathrm{RM}} \end{array}\right\}$ | $\begin{aligned} & I_{F}=60 \mathrm{~A},-\mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s} \\ & \mathrm{~V}_{\mathrm{R}}=100 \mathrm{~V} \end{aligned}$ |  | $\begin{array}{r} 140 \\ 880 \\ 12.6 \\ \hline \end{array}$ |  | ns nC A |

Note 1. Pulse test, $\mathrm{t} \leq 300 \mu \mathrm{~s}$, duty cycle, $\mathrm{d} \leq 2 \%$.

## PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

Fig. 1. Output Characteristics @ $\mathrm{T}_{\mathbf{J}}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$


Fig. 3. Output Characteristics @ $\mathrm{T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$


Fig. 5. RDS(on) Normalized to $I_{D}=60 \mathrm{~A}$ Value vs.
Drain Curren


Fig. 2. Extended Output Characteristics @ $\mathrm{T}_{\mathrm{J}}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$


Fig. 4. RDS(on) Normalized to $\mathrm{I}_{\mathrm{D}}=60 \mathrm{~A}$ Value vs. Junction Temperature


Fig. 6. Normalized Breakdown \& Threshold Voltages
vs. Junction Temperature


Fig. 7. Maximum Drain Current vs. Case Temperature


Fig. 9. Transconductance


Fig. 11. Gate Charge


Fig. 8. Input Admittance


Fig. 10. Forward Voltage Drop of Intrinsic Diode


Fig. 12. Capacitance


IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

Fig. 13. Output Capacitance Stored Energy


Fig. 14. Forward-Bias Safe Operating Area


Fig. 15. Maximum Transient Thermal Impedance

IXFT120N25X3HV IXFQ120N25X3 IXFH120N25X3

## TO-268HV Outline



PINS:
1-Gate 2-Source
3 - Drain


| SYM | INCHES |  | MILLIMETER |  |
| :--- | :---: | :---: | :---: | ---: |
|  | MIN | MAX | MIN | MAX |
| A | .193 | .201 | 4.90 | 5.10 |
| A1 | .106 | .114 | 2.70 | 2.90 |
| A2 | .001 | .010 | 0.02 | 0.25 |
| b | .045 | .057 | 1.15 | 1.45 |
| C | .016 | .026 | 0.40 | 0.65 |
| C2 | .057 | .063 | 1.45 | 1.60 |
| D | .543 | .551 | 13.80 | 14.00 |
| D 1 | .465 | .476 | 11.80 | 12.10 |
| D2 | .295 | .307 | 7.50 | 7.80 |
| D3 | .114 | .126 | 2.90 | 3.20 |
| E | .624 | .632 | 15.85 | 16.05 |
| E1 | .524 | .535 | 13.30 | 13.60 |
| El | .215 | BSC | 5.45 |  |
| BSC |  |  |  |  |
| (e2) | .374 | .386 | 9.50 | 9.80 |
| H | .736 | .752 | 18.70 | 19.10 |
| L | .067 | .079 | 1.70 | 2.00 |
| L2 | .039 | .045 | 1.00 |  |



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